

## SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

### **5LN01M**

N-Channel Silicon MOSFET

# **General-Purpose Switching Device Applications**

#### **Features**

- · Low ON-resistance.
- · Ultrahigh-speed switching.
- · 2.5V drive.

#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	V <sub>DSS</sub>		50	V
Gate-to-Source Voltage	VGSS		±10	٧
Drain Current (DC)	ID		0.1	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	0.4	Α
Allowable Power Dissipation	PD		0.15	W
Channel Temperature	Tch		150	ô
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Drain-to-Source Breakdown Voltage	V(BR)DSS	I <sub>D</sub> =1mA, V <sub>GS</sub> =0V	50			V
Zero-Gate Voltage Drain Current	IDSS	VDS=50V, VGS=0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V <sub>DS</sub> =10V, I <sub>D</sub> =100μA	0.4		1.3	V
Forward Transfer Admittance	yfs	VDS=10V, ID=50mA	0.13	0.18		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	ID=50mA, VGS=4V		6	7.8	Ω
	R <sub>DS</sub> (on)2	I <sub>D</sub> =30mA, V <sub>G</sub> S=2.5V		7.1	9.9	Ω
	RDS(on)3	ID=10mA, VGS=1.5V		10	20	Ω
Input Capacitance	Ciss	V <sub>DS</sub> =10V, f=1MHz		6.6		pF
Output Capacitance	Coss	V <sub>DS</sub> =10V, f=1MHz		4.7		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =10V, f=1MHz		1.7		pF

Marking: YB Continued on next page.

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#### **5LN01M**

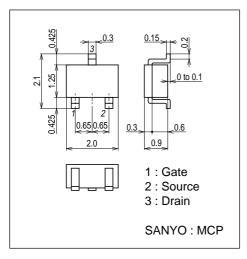
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Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		18		ns
Rise Time	tr	See specified Test Circuit.		42		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		190		ns
Fall Time	tf	See specified Test Circuit.		105		ns
Total Gate Charge	Qg	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =100mA		1.57		nC
Gate-to-Source Charge	Qgs	VDS=10V, VGS=10V, ID=100mA		0.20		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =100mA		0.32		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =100mA, V <sub>GS</sub> =0V		0.85	1.2	V

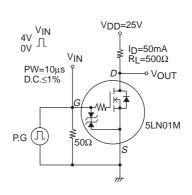
#### **Package Dimensions**

unit: mm 7023-010

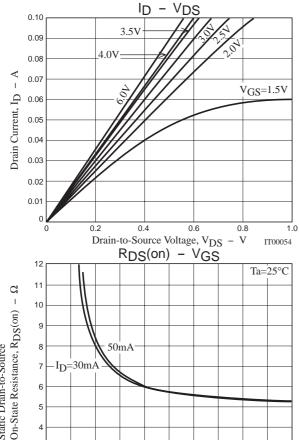
Static Drain-to-Source



#### **Switching Time Test Circuit**



0.20



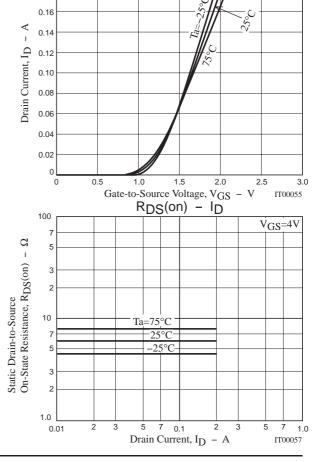
50mA

6

IT00056

Gate-to-Source Voltage,  $V_{GS} - V$ 

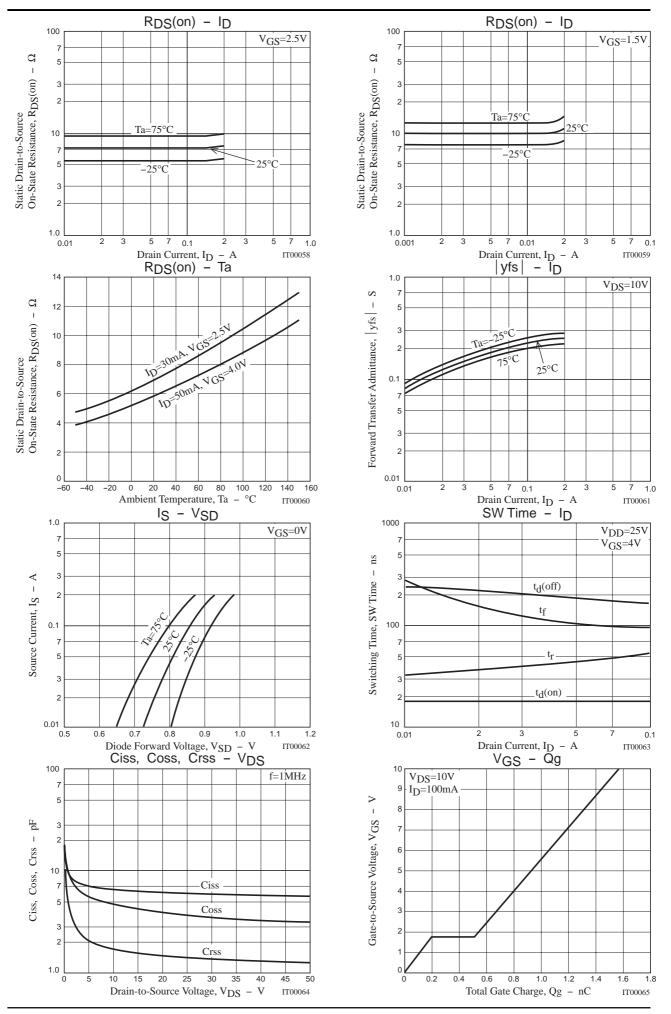
 $7 - I_D = 30 \text{mA}$ 

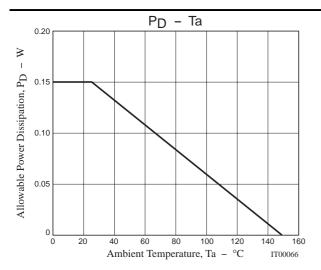


ID - VGS

 $\dot{V}_{DS}=10V$ 

#### **5LN01M**





Note on usage: Since the 5LN01M is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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